Specification of Thermoelectric Module

TEC1-02708S1CH4.0

Description

The 27 couples, 20mm x 20mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70° C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

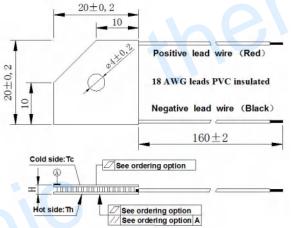
Performance Specification Sheet

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U _{max} (Voltage)	3.4	3.7	Voltage applied to the module at DT _{max}	
I _{max} (Amps)	8.3	8.3	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	17.6	18.9	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (Ohms)	0.32	0.34	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters



Ordering Option

Manufacturing Options

A. Solder:	B. Sealant:	
1. T100: BiSn (Tmelt=138°C)	1. NS: No sealing (Standard)	
2. T200: CuAgSn (Tmelt = 217°C)	2. SS: Silicone sealant	
3. T240: SbSn (Tmelt = 240°C)	3. EPS: Epoxy sealant	
C. Ceramics:	D. Ceramics Surface Options:	
1. Alumina (Al ₂ O ₃ , white 96%)	1. Blank ceramics (not metalized)	

2. Aluminum Nitride (AlN)

2. Metalized

D Coolont

Naming for the Module

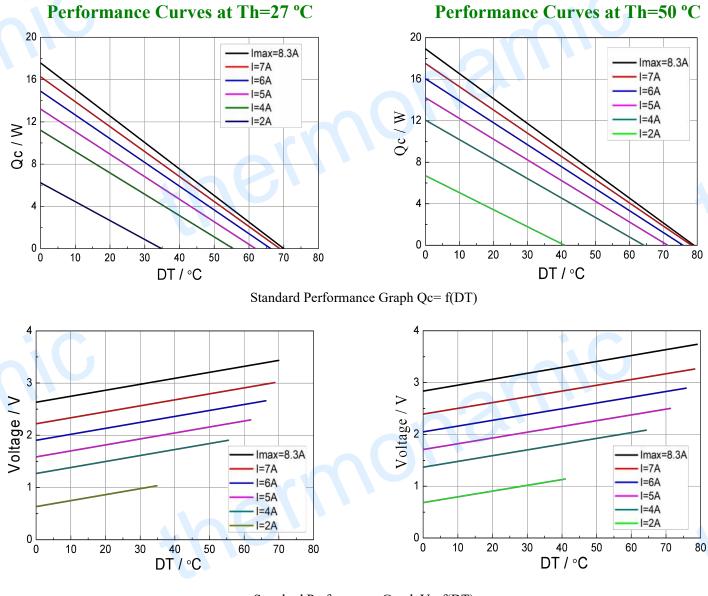
TF21: Thickness ±0.025(mm) and Flatness/ Parallelism 0.025/0.025 (mm)

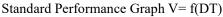
Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length	TEC1-02708S1CH4.0- X -X	-X - X
TF	0:3.5± 0.1	0: 0.05/0.05	160±2/Specify		Flatness/ Parallelism
TF	$1{:}3.5\pm0.03$	1: 0.02/0.02	160±2/Specify	TEC1-02708S1CH4.0-T100	
Eg. TF01: Thickness 3.5 ± 0.1 (mm) and Flatness $0.02/0.02$ (mm)				CH4.0: Center hole diameter 4.0mm NS: No sealing	T100: BiSn (Tmelt=138°C) AlO: Alumina (Al2O3, white 96%)

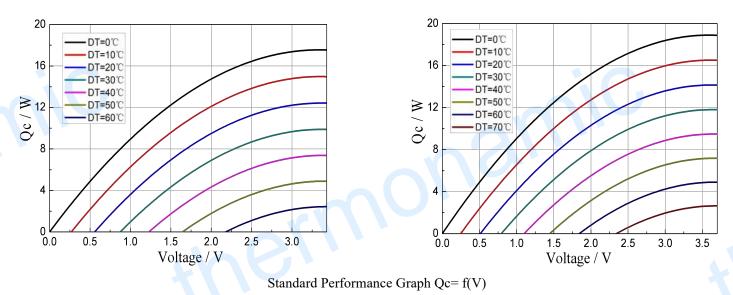
Creative technology with fine manufacturing processes provides you the reliable and quality products Tel: +86-791-88198288 Fax: +86-791-88198308 Email: <u>sales@thermonamic.com.cn</u> Web Site: www.thermonamic.com.cn

Specification of Thermoelectric Module

TEC1-02708S1CH4.0



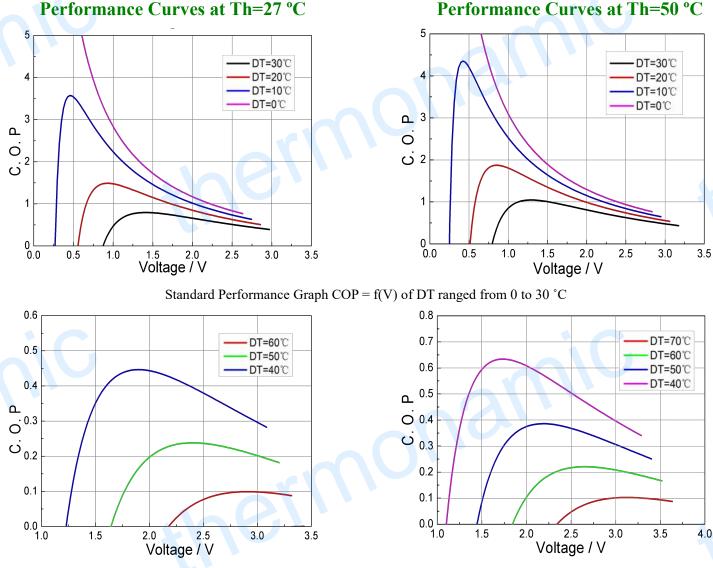




Creative technology with fine manufacturing processes provides you the reliable and quality products Tel: +86-791-88198288 Fax: +86-791-88198308 Email: <u>sales@thermonamic.com.cn</u> Web Site: www.thermonamic.com.cn

Specification of Thermoelectric Module

TEC1-02708S1CH4.0



Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Caution

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.